

# UNISONIC TECHNOLOGIES CO., LTD

1N70K-TA **Preliminary Power MOSFET** 

# 1.2A, 700V N-CHANNEL POWER MOSFET

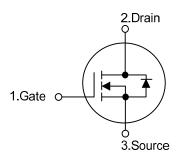
#### DESCRIPTION

The UTC 1N70K-TA is a high voltage MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

#### **FEATURES**

- \*  $R_{DS(ON)}$  < 13.5 $\Omega$  @  $V_{GS}$  = 10V,  $I_{D}$  = 0.5A
- \* Fast switching capability
- \* Avalanche energy specified
- \* Improved dv/dt capability, high ruggedness

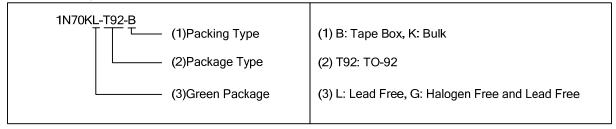




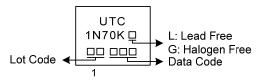
#### ORDERING INFORMATION

Ordering Number		Daakaga	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
1N70KL-x-T92-B	1N70KG-x-T92-B	TO-92	G	D	S	Tape Box	
1N70KL-x-T92-K	1N70KG-x-T92-K	TO-92	G	D	S	Bulk	

Pin Assignment: G: Gate S: Source Note: D: Drain



### **MARKING**



1 TO-92

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# ■ ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, unless otherwise specified)

PARAMETE	SYMBOL	RATINGS	UNIT	
Drain-Source Voltage	$V_{DSS}$	700	V	
Gate-Source Voltage		$V_{GSS}$	±30	V
Continuous Drain Current	Continuous	$I_{D}$	1.0	Α
Pulsed Drain Current	Pulsed (Note 2)	$I_{DM}$	4.0	Α
Avalanche Current (Note 2)	$I_{AR}$	1.0	Α	
Single Pulsed Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	5	mJ
Peak Diode Recovery dv/dt (Note 4	dv/dt	4.5	V/ns	
Power Dissipation	$P_{D}$	1.6	W	
Junction Temperature	TJ	+150	°C	
Storage Temperature	$T_{STG}$	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 10mH,  $I_{AS}$  = 1.0A,  $V_{DD}$  = 50V,  $R_{G}$  = 25 $\Omega$ , Starting  $T_{J}$  = 25 $^{\circ}$ C
- 4.  $I_{SD} \le 1.0 A$ , di/dt  $\le 200 A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25 ^{\circ}C$ .

#### ■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	$\theta_{JA}$	140	°C/W	
Junction to Case	$\theta_{JC}$	80	°C/W	

#### ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub> =25°C, unless otherwise specified)

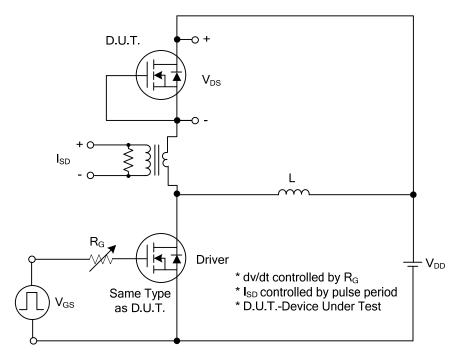
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS	_							
Drain-Source Breakdown Voltage		$BV_{DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	700			V	
Drain-Source Leakage Current		$I_{DSS}$	V <sub>DS</sub> = 700V, V <sub>GS</sub> = 0V			1	μΑ	
Gate-Source Leakage Current	Forward	- I <sub>GSS</sub>	$V_{GS} = 30V, V_{DS} = 0V$			100	nA	
	Reverse		$V_{GS} = -30V$ , $V_{DS} = 0V$			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V	
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	$V_{GS} = 10V, I_D = 0.5A$			13.5	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance		$C_{ISS}$			190		pF	
Output Capacitance		Coss	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1MHz		25		pF	
Reverse Transfer Capacitance		$C_{RSS}$			10		pF	
<b>SWITCHING CHARACTERISTIC</b>	S							
Rise Time (Note 1)		$Q_G$	V <sub>DS</sub> =50V, V <sub>GS</sub> =10V, I <sub>D</sub> =1.3A,		14		nC	
Turn-OFF Delay Time		$Q_GS$	I <sub>G</sub> =100µA (Note 1, 2)		2.8		nC	
Fall-Time		$Q_GD$	IG-100μΑ (Note 1, 2)		1		nC	
Total Gate Charge (Note 1)		$t_{D(ON)}$			35		ns	
Gate to Source Charge		$t_R$	$V_{DD}$ =30V, $V_{GS}$ =10V,		20		ns	
Gate to Drain Charge		$t_{D(OFF)}$	$I_D = 0.5A, R_G = 25\Omega \text{ (Note 1, 2)}$		45		ns	
Turn-ON Delay Time		$t_{F}$			8		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous Current		I <sub>S</sub>				1.0	Α	
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				4.0	Α	
Drain-Source Diode Forward Voltage (Note 1)		$V_{\text{SD}}$	I <sub>S</sub> =1.0A, V <sub>GS</sub> =0V			1.4	V	
Body Diode Reverse Recovery Time (Note 1)		t <sub>rr</sub>	I <sub>S</sub> =1.0A, V <sub>GS</sub> =0V,		310		nS	
Body Diode Reverse Recovery Charge		$Q_{rr}$	dI <sub>F</sub> /dt=100A/μs		0.65		μC	

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

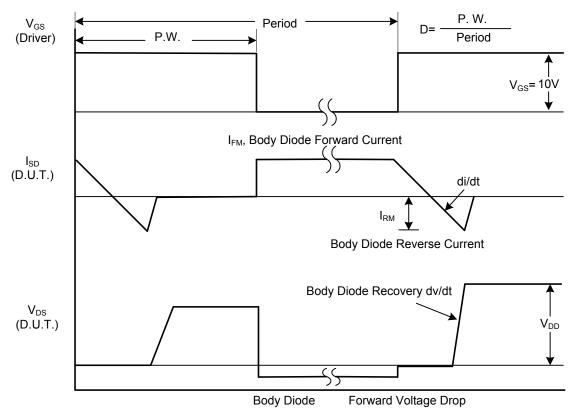
2. Essentially independent of operating temperature.



## ■ TEST CIRCUITS AND WAVEFORMS

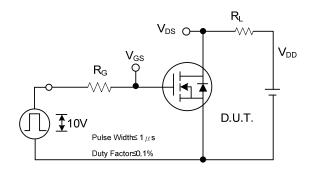


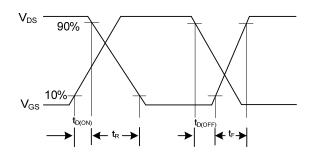
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

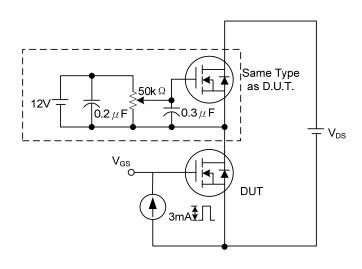
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

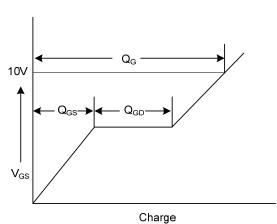




**Switching Test Circuit** 

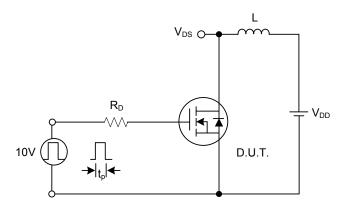
**Switching Waveforms** 

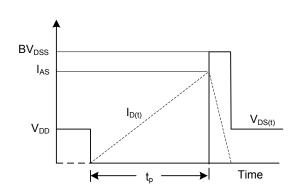




**Gate Charge Test Circuit** 

**Gate Charge Waveform** 





**Unclamped Inductive Switching Test Circuit** 

**Unclamped Inductive Switching Waveforms** 

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